

2.0x1.25mm SMD CHIP LED LAMP

PRELIMINARY SPEC



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Part Number: KP-2012VGC-Z

GREEN

Features

- •2.0mmx1.25mm SMT LED,1.1mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS/REEL.
- •MOISTURE SENSITIVITY LEVEL: LEVEL 3.
- •RoHS COMPLIANT.

Description

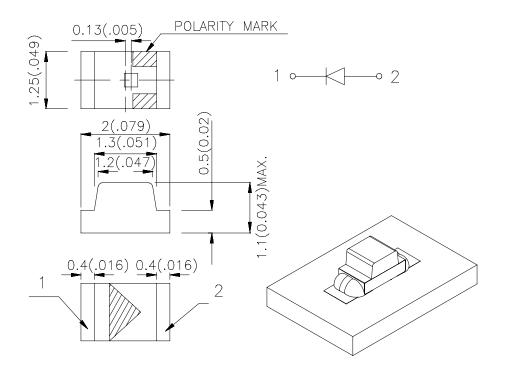
The Green source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.

 3. Specifications are subject to change without notice.
- 4. The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	2 θ 1/2
KP-2012VGC-Z	GREEN (InGaN)	WATER CLEAR	380	800	120°

Notes:

 $1.\,01/2$ is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2.Luminous Intensity / Luminous Flux: +/-15%.

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	525		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	535		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	39		nm	IF=20mA
С	Capacitance	Green	65		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.2	3.7	V	IF=20mA
lr	Reverse Current	Green		10	uA	VR = 5V

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at Ta=25°C

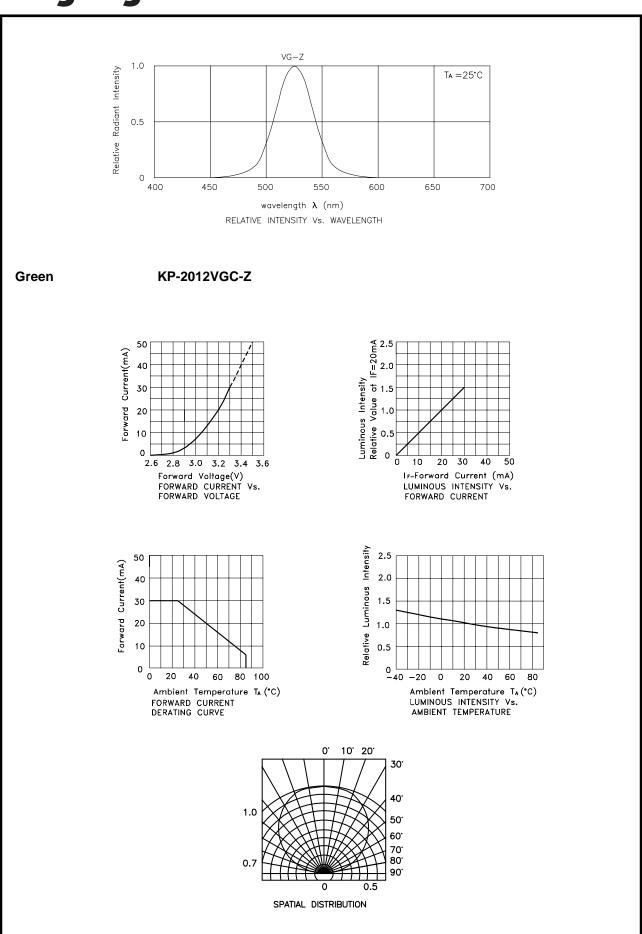
Parameter	Green	Units
Power dissipation	111	mW
DC Forward Current	30	mA
Peak Forward Current [1]	100	mA
Reverse Voltage	5	V
Operating / Storage Temperature -40°C To +85°C		

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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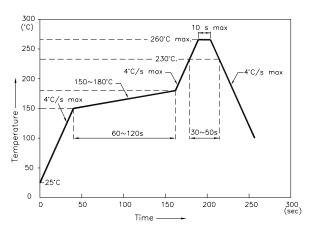


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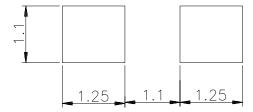
Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

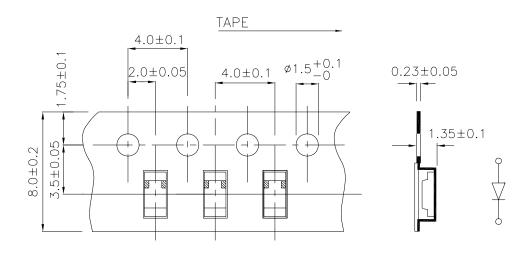
 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
 - 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ±0.1)



Tape Specifications

(Units: mm)



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